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General Description

The LTC882x family of single-, dual-, and quad- channel amplifiers features a maximized ratio of gain bandwidth (GBW) to supply current and is ideal for battery-powered applications such as wearables, handsets, tablets, and portable medical devices. Featuring rail-to-rail input and output swings, a wide bandwidth of 500-kHz combined with ultra-low supply current (typical 6.6 μ A at V_S=5.5V per amplifier) and low noise (6 μ V_{P-P} at 0.1 to 10 Hz), the LTC882x family is an excellent choice for precision or general-purpose, low-current, low-voltage, battery-powered applications. The low input bias current supports these amplifiers to be used in applications with mega-ohm source impedances.

The robust design of the LTC882x operational amplifiers provides ease-of-use to the circuit designer: integrated RF/EMI rejection filter, no phase reversal in overdrive conditions, and high electro-static discharge (ESD) protection (5-kV HBM). The LTC882x amplifiers are optimized for operation at voltages as low as +1.8 V (\pm 0.9 V) and up to +5.5 V (\pm 2.75 V).

The LTC8821 (single) is available in both SOT23-5L and SC70-5L packages. The LTC8822 (dual) is offered in DFN-8L, SOIC-8L and MSOP-8L packages. The quad-channel LTC8824 is offered in both SOIC-14L and TSSOP-14L packages. All of the devices are specified over the extended temperature range of -40 $^{\circ}$ C to +125 $^{\circ}$ C.

Features and Benefits

- 500 kHz GBW
- Ultra-Low 6.6 μA Supply Current (at 5.5V Supply, Per Amplifier)
- Low Input Offset Voltage: 0.5 mV
- Low Noise: 6 μV_{P-P} at 0.1 to 10 Hz
- Single 1.8 V to 5.5 V Supply Voltage Range
- Rail-to-Rail Input and Output
- Internal RF/EMI Filter
- Extended Temperature Range: -40°C to +125°C

Applications

- Battery-Powered Instruments:
 Consumer, Industrial, Medical, Notebooks
- Wearable Fitness Devices
- Audio Outputs
- Sensor Signal Conditioning:
 - Sensor Interfaces, Loop-Powered, Active Filters
- Wireless Sensors:
 Home Security, Remote Sensing, Wireless Metering

Pin Configurations (Top View)



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LTC8821, LTC8822, LTC8824 Ultra-Low Power 500kHz, 1.8V, Low-Noise, RRIO CMOS Amplifiers

Pin Description

Symbol	Description
-IN	Inverting input of the amplifier.
+IN	Non-inverting input of the amplifier.
+V _S	Positive (highest) power supply.
-V _s	Negative (lowest) power supply.
OUT	Amplifier output.

Ordering Information

Type Number	Package Name	Package Quantity	Marking Code
LTC8821XT5/R6	S0T23-5	Tape and Reel, 3 000	AL1
LTC8821XC5/R6	SC70-5	Tape and Reel, 3 000	AL1
LTC8822XF8/R6	DFN2x2-8L	Tape and Reel, 3 000	AL2
LTC8822XF8S/R10	DFN1.5x1.5-8L	Tape and Reel, 5 000	AL2
LTC8822XS8/R8	S0-8	Tape and Reel, 4 000	AL2 X
LTC8822XV8/R6	MSOP-8	Tape and Reel, 3 000	AL2X
LTC8823XT5/R6	S0T23-5	Tape and Reel, 3 000	AL3
LTC8823XC5/R6	SC70-5	Tape and Reel, 3 000	AL3
LTC8824XS14/R5	S0-14	Tape and Reel, 2 500	AL4 X
LTC8824XT14/R6	TSSOP-14	Tape and Reel, 3 000	AL4 X

Limiting Value

In accordance with the Absolute Maximum Rating System (IEC 60134).

Parameter	Absolute Maximum Rating
Supply Voltage, V_{S+} to V_{S-}	10.0 V
Signal Input Terminals: Voltage, Current	$\rm V_{S_{-}}$ – 0.3 V to $\rm V_{S*}$ + 0.3 V, $\pm 10~mA$
Output Short-Circuit	Continuous
Storage Temperature Range, T _{stg}	–65 ℃ to +150 ℃
Junction Temperature, T _J	150 °C
Lead Temperature Range (Soldering 10 sec)	260 ℃

ESD Rating

Parameter	Item	Value	Unit
Electrostatic	Human body model (HBM), per MIL-STD-883J / Method 3015.9 ⁽¹⁾	\pm 5 000	
Discharge Voltage	Charged device model (CDM), per ESDA/JEDEC JS-002-2014 $^{(2)}$	\pm 2 000	V
	Machine model (MM), per JESD22-A115C	\pm 250	

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
 (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

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Electrical Characteristics

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 $V_S = 5.0V$, $T_A = +25^{\circ}C$, $V_{CM} = V_S/2$, $V_0 = V_S/2$, and $R_L = 10k\Omega$ connected to $V_S/2$, unless otherwise noted. Boldface limits apply over the specified temperature range, $T_A = -40$ to +125 °C.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
OFFSET	OLTAGE						
V	Input offect veltage			±0.5	± 2.5	- m\/	
V _{os}	Input offset voltage	T _A = −40 to +125 °C			±2.8	— mV	
V _{os} TC	Offset voltage drift	T _A = −40 to +125 °C		±0.5	±3	μV/°C	
PSRR	Power supply	$\rm V_{S}$ = 2.0 to 5.5 V, $\rm V_{CM}$ < $\rm V_{S+}$ – 2V	98	115		– dB	
	rejection ratio	T _A = −40 to +125 °C	88			uD	
INPUT BI	AS CURRENT						
				1		_	
I _B	Input bias current	T _A = +85 °C		150		pА	
		T _A = +125 °C		500			
l _{os}	Input offset current			1		pА	
NOISE							
V _n	Input voltage noise	f = 0.1 to 10 Hz		6		μV_{P-P}	
0	Input voltage noise	f = 10 kHz		62		— nV/√Hz	
e _n	density	f = 1 kHz		63		110/0112	
I _n	Input current noise density	f = 1 kHz		5		fA/√Hz	
INPUT VC							
	Common-mode		V _{s-} -0.1		V _{S+} +0.1		
Vall	voltage range	T _A = −40 to +125 °C	V _{S-}		V _{s+} -0.1	– v	
		V _S = 5.5 V, V _{CM} = −0.1 to 5.5 V	76	92			
	Common-mode	V_{CM} = 0 to 5.3 V, T_A = -40 to +125 °C	70				
CMRR	rejection ratio	V _S = 2.0 V, V _{CM} = -0.1 to 2.0 V	72	86		— dB —	
		V_{CM} = 0 to 1.8 V, T_A = -40 to +125 °C	68				
INPUT IM	PEDANCE						
R _{IN}	Input resistance		100			GΩ	
<u> </u>	Innut conscitones	Differential		2.0			
C _{IN}	Input capacitance	Common mode		3.5		– pF	
OPEN-LC	OOP GAIN						
		R_L = 25 kΩ, V ₀ = 0.05 to 3.5 V	86	97		_	
•	Open-loop voltage	T _A = −40 to +125 °C	80				
A _{VOL}	gain	R_{L} = 5 kΩ, V ₀ = 0.15 to 3.5 V	80	92		– dB	
		T _A = −40 to +125 °C	74				
FREQUEI	NCY RESPONSE						
GBW	Gain bandwidth			500		kHz	
SR	product Slew rate	G = +1, C ₁ = 100 pF, V ₀ = 1.5 to 3.5 V		0.25		V/µs	
	Total harmonic	$G = +1, f = 1 \text{ kHz}, R_1 = 2 \text{ k}\Omega,$					
THD+N	distortion + noise	$V_0 = 1 V_{RMS}$		0.005	%		
+	Settling time	To 0.1%, G = +1, 1V step		6			
t _s	Settling time	To 0.01%, G = +1, 1V step		7		– μs	

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Electrical Characteristics (continued)

 $V_S = 5.0V$, $T_A = +25^{\circ}C$, $V_{CM} = V_S/2$, $V_0 = V_S/2$, and $R_L = 10k\Omega$ connected to $V_S/2$, unless otherwise noted. Boldface limits apply over the specified temperature range, $T_A = -40$ to +125 °C.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
t _{or}	Overload recovery time	To 0.1%, V _{IN} * Gain > V _S		10		μs	
OUTPUT							
V	High output voltage	R _L = 25 kΩ	V _{S+} -8	V _{S+} -5		- mV	
V _{OH} swing	swing	$R_{L} = 5 k\Omega$	V _{S+} -36	V _{S+} -26		· mv	
V	Low output voltage	R _L = 25 kΩ		V _{S-} +4	V _{S-} +6		
V _{oL} swing	swing	R _L = 5 kΩ		V _{S-} +16	V _{S-} +24	- mV	
I _{sc}	Short-circuit current			± 45		mA	
POWER S	UPPLY						
Vs	Operating supply voltage		1.8		5.5	V	
		V _S = 2.0V, T _A = +25°C		5.2	6.5	- μA	
Iα	Quiescent current (per amplifier)	V _S = 5.5V, T _A = +25°C		6.6	8.5		
	(por empirior)	T _A = −40 to +125 °C			12	-	
THERMAL	CHARACTERISTICS						
T _A	Operating temperature range		-40		+125	°C	
		SC70-5L		333			
		SOT23-5L		190		-	
		DFN2x2-8L		80		-	
θ _{JA}	Package Thermal Resistance	MSOP-8L		216		°C/W	
	Resistance	SOIC-8L		125		-	
		TSSOP-14L		112		-	
		SOIC-14L		115		-	

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Typical Performance Characteristics

At $T_A = +25^{\circ}C$, $V_{CM} = V_S/2$, and $R_L = 10k\Omega$ connected to $V_S/2$, unless otherwise noted.



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Typical Performance Characteristics (continued)

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At $T_A = +25$ °C, $V_{CM} = V_S/2$, and $R_L = 10 k\Omega$ connected to $V_S/2$, unless otherwise noted.



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Typical Performance Characteristics (continued)

At $T_A = +25^{\circ}C$, $V_{CM} = V_S/2$, and $R_L = 10k\Omega$ connected to $V_S/2$, unless otherwise noted.



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Application Notes

Featuring a maximized ratio of GBW-to-supply current, low operating supply voltage, low input bias current, and rail-to-rail inputs and outputs, the LTC882x family is an excellent choice for precision general-purpose, low-current, low-voltage, or battery-powered applications. These CMOS operational amplifiers consume an ultra-low 6.6-µA (typically at 5.5-V supply voltage) supply current per amplifier. The LTC882x family is unity-gain stable with a 500-kHz GBW product, driving capacitive loads up to 20-pF. The capacitive load can be increased to 500-pF when the amplifier is configured for a 5-V/V gain.

OPERATING VOLTAGE

The LTC882x family is optimized for operation at voltages as low as +1.8 V (\pm 0.9 V) and up to +5.5 V (\pm 2.75 V). In addition, many specifications apply from -40 °C to +125 °C. Parameters that vary significantly with operating voltages or temperature are illustrated in the Typical Characteristics graphs.

RAIL-TO-RAIL INPUT

The input common-mode voltage range of the LTC882x series extends 100-mV beyond the negative and positive supply rails. This performance is achieved with a complementary input stage: an Nchannel input differential pair in parallel with a Pchannel differential pair. The N-channel pair is active for input voltages close to the positive rail, typically V_{S+} -1.4 V to the positive supply, whereas the Pchannel pair is active for inputs from 100-mV below the negative supply to approximately $\rm V_{S*}\mathchar`-1.4$ V. There is a small transition region, typically V_{S+} -1.2 V to V_{S+} -1 V, in which both pairs are on. This 200-mV transition region can vary up to 200-mV with process variation. Thus, the transition region (both stages on) can range from V_{S+} -1.4 V to V_{S+} -1.2 V on the low end, up to V_{S+} -1 V to V_{S+} -0.8 V on the high end. Within this transition region, PSRR, CMRR, offset voltage, offset drift, and THD can be degraded compared to device operation outside this region.

The typical input bias current of the LTC882x opamps during normal operation is approximately 1-pA. In overdriven conditions, the bias current can increase significantly. The most common cause of an overdriven condition occurs when the operational amplifier is outside of the linear range of operation. When the output of the operational amplifier is driven to one of the supply rails, the feedback loop requirements cannot be satisfied and a differential input voltage develops across the input pins. This differential input voltage results in activation of parasitic diodes inside the front-end input chopping switches that combine with electromagnetic interference (EMI) filter resistors to create the equivalent circuit. Notice that the input bias current remains within specification in the linear region.

INPUT EMI FILTER AND CLAMP CIRCUIT

Figure 1 shows the input EMI filter and clamp circuit. The LTC882x op-amps have internal ESD protection diodes (D1, D2, D3, and D4) that are connected between the inputs and each supply rail. These diodes protect the input transistors in the event of electrostatic discharge and are reverse biased during normal operation. This protection scheme allows voltages as high as approximately 300-mV beyond the rails to be applied at the input of either terminal without causing permanent damage. These ESD protection current-steering diodes also provide in-circuit, input overdrive protection, as long as the current is limited to 10-mA as stated in the Absolute Maximum Ratings.



Figure 1. Input EMI Filter and Clamp Circuit

Operational amplifiers vary in susceptibility to EMI. If conducted EMI enters the operational amplifier, the dc offset at the amplifier output can shift from its nominal value when EMI is present. This shift is a result of signal rectification associated with the internal semiconductor junctions. Although all operational amplifier pin functions can be affected by EMI, the input pins are likely to be the most susceptible. The EMI filter of the LTC882x family is composed of two 5-k Ω input series resistors (R_{S1} and R_{S2}), two common-mode capacitors (C_{CM1} and C_{CM2}), and a differential capacitor (C_{DM}). These RC networks set the -3 dB low-pass cutoff frequencies at 35-MHz for common-mode signals, and at 22-MHz for differential signals.

RAIL-TO-RAIL OUTPUT

Designed as a micro-power, low-noise operational amplifier, the LTC882x delivers a robust output drive capability. A class AB output stage with common-source transistors is used to achieve full rail-to-rail output swing capability. For resistive loads up to 25-k Ω , the output swings typically to within 5 mV of either supply rail regardless of the power-supply voltage applied. Different load conditions change the ability of the amplifier to swing close to the rails. For resistive loads up to 5-k Ω , the output swings typically to within 26-mV of the positive supply rail and within 16-mV of the negative supply rail.



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Application Notes (continued)

CAPACITIVE LOAD AND STABILITY

The LTC882x family of operational amplifiers is unity-gain stable for loads up to 20-pF. However, the capacitive load can be increased to 500-pF when the amplifier is configured for a minimum gain of 5-V/V.

As with most amplifiers, driving larger capacitive loads than specified may cause excessive overshoot and ringing, or even oscillation. A heavy capacitive load reduces the phase margin and causes the amplifier frequency response to peak. Peaking corresponds to overshooting or ringing in the time domain. Therefore, it is recommended that external compensation be used if the LTC882x family requires greater capacitive-drive capability. This compensation is particularly important in the unitygain configuration, which is the worst case for stability.

A quick and easy way to stabilize the op-amp for capacitive load drive is by adding a series resistor, $R_{\rm ISO}$, between the amplifier output terminal and the load capacitance, as shown in Figure 2. $R_{\rm ISO}$ isolates the amplifier output and feedback network from the capacitive load. The bigger the $R_{\rm ISO}$ resistor value, the more stable $V_{\rm OUT}$ will be. Note that this method results in a loss of gain accuracy because $R_{\rm ISO}$ forms a voltage divider with the $R_{\rm L}$. In unity gain applications with relatively small $R_{\rm L}$ (approximately 5-kΩ), the capacitive load can be increased up to 100-pF.



Figure 2. Indirectly Driving Heavy Capacitive Load

An improvement circuit is shown in Figure 3. It provides DC accuracy as well as AC stability. The R_F provides the DC accuracy by connecting the inverting signal with the output.



Figure 3. Indirectly Driving Heavy Capacitive Load with DC Accuracy

The C_F and $R_{\rm ISO}$ serve to counteract the loss of phase margin by feeding the high frequency component of the output signal back to the amplifier's inverting input, thereby preserving phase margin in the overall feedback loop.

For no-buffer configuration, there are two others ways to increase the phase margin: (a) by increasing the amplifier's gain, or (b) by placing a capacitor in parallel with the feedback resistor to counteract the parasitic capacitance associated with inverting node.

OVERLOAD RECOVERY

Overload recovery is defined as the time required for the operational amplifier output to recover from a saturated state to a linear state. The output devices of the operational amplifier enter a saturation region when the output voltage exceeds the rated operating voltage, either because of the high input voltage or the high gain. After the device enters the saturation region, the charge carriers in the output devices require time to return back to the linear state. After the charge carriers return back to the linear state, the device begins to slew at the specified slew rate. Thus, the propagation delay in case of an overload condition is the sum of the overload recovery time and the slew time. The overload recovery time for the LTC882x family is approximately 10-µs.

EMI REJECTION RATIO

Circuit performance is often adversely affected by high frequency EMI. When the signal strength is low and transmission lines are long, an op-amp must accurately amplify the input signals. However, all opamp pins — the non-inverting input, inverting input, positive supply, negative supply, and output pins are susceptible to EMI signals. These high frequency signals are coupled into an op-amp by various means, such as conduction, near field radiation, or far field radiation. For example, wires and printed circuit board (PCB) traces can act as antennas and pick up high frequency EMI signals.

Amplifiers do not amplify EMI or RF signals due to their relatively low bandwidth. However, due to the nonlinearities of the input devices, op-amps can rectify these out of band signals. When these high frequency signals are rectified, they appear as a dc offset at the output.

The LTC882x op-amps have integrated EMI filters at their input stage. A mathematical method of measuring EMIRR is defined as follows:

 $EMIRR = 20 \log \left(V_{IN_PEAK} / \Delta V_{OS} \right)$

INPUT-TO-OUTPUT COUPLING

To minimize capacitive coupling, the input and output signal traces should not be parallel. This helps reduce unwanted positive feedback.



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Application Notes (continued)

MAXIMIZING PERFORMANCE THROUGH PROPER LAYOUT

To achieve the maximum performance of the extremely high input impedance and low offset voltage of the LTC882x op-amps, care is needed in laying out the circuit board. The PCB surface must remain clean and free of moisture to avoid leakage currents between adjacent traces. Surface coating of the circuit board reduces surface moisture and provides a humidity barrier, reducing parasitic resistance on the board. The use of guard rings around the amplifier inputs further reduces leakage currents. Figure 4 shows proper guard ring configuration and the top view of a surface-mount layout. The guard ring does not need to be a specific width, but it should form a continuous loop around both inputs. By setting the guard ring voltage equal to the voltage at the non-inverting input, parasitic capacitance is minimized as well. For further reduction of leakage currents, components can be mounted to the PCB using Teflon standoff insulators.



Figure 4. Use a guard ring around sensitive pins

Other potential sources of offset error are thermoelectric voltages on the circuit board. This voltage, also called Seebeck voltage, occurs at the junction of two dissimilar metals and is proportional to the temperature of the junction. The most common metallic junctions on a circuit board are solder-toboard trace and solder-to-component lead. If the temperature of the PCB at one end of the component is different from the temperature at the other end, the resulting Seebeck voltages are not equal, resulting in a thermal voltage error.

This thermocouple error can be reduced by using dummy components to match the thermoelectric error source. Placing the dummy component as close as possible to its partner ensures both Seebeck voltages are equal, thus canceling the thermocouple error. Maintaining a constant ambient temperature on the circuit board further reduces this error. The use of a ground plane helps distribute heat throughout the board and reduces EMI noise pickup.



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Typical Application Circuits

DIFFERENTIAL AMPLIFIER

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Figure 5. Differential Amplifier

The circuit shown in Figure 5 performs the difference function. If the resistors ratios are equal $R_{L}/R_{3} = R_{2}/R_{1}$ then:

 $V_{OUT} = (V_p - V_p) \times R_2/R_1 + V_{REF}$

INSTRUMENTATION AMPLIFIER



Figure 6. Instrumentation Amplifier

The LTC882x family is well suited for conditioning sensor signals in battery-powered applications. Figure 6 shows a two op-amp instrumentation amplifier, using the LTC882x op-amps. The circuit works well for applications requiring rejection of common-mode noise at higher gains. The reference voltage (V_{REF}) is supplied by a low-impedance source. In single voltage supply applications, the V_{REF} is typically $V_s/2$.

BATTERY MONITORING

The low operating voltage and guiescent current of the LTC882x family make it an excellent choice for battery monitoring applications, as shown in Figure 7. In this circuit, V_{STATUS} is high as long as the battery voltage remains above 2-V (V_{REF} = 1.2V). A low-power reference is used to set the trip point. Resistor values are selected as follows:

- R_F Selecting: Select R_F such that the current 1. through R_{r} is approximately 1000x larger than the maximum bias current over temperature: $R_{F} = V_{REF} \div (1000 \times I_{BMAX}) = 1.2V \div (1000 \times 100 pA) =$ 12MΩ ≈ 10MΩ
- 2. Choose the hysteresis voltage, V_{HYST}. For battery

monitoring applications, 50-mV is adequate.

- 3. Calculate R₁ as follows: $R_1 = R_F \times (V_{HYST} \div V_{BATT}) \approx 10M\Omega \times (50mV \div 2.4V) =$ 210kΩ
- 4. Select a threshold voltage for V_{IN} rising (V_{TS}) = 2.0V.
- 5. Calculate R₂ as follows: $\begin{array}{l} \mathsf{R}_2 = 1 \div [\mathsf{V}_{\mathsf{TS}} \div (\mathsf{V}_{\mathsf{REF}} \times \mathsf{R}_1) - 1 \div \mathsf{R}_1 - 1 \div \mathsf{R}_F] = \\ 1 \div [2V \div (1.2V \times 210 \mathrm{k\Omega}) - 1 \div 210 \mathrm{k\Omega} - 1 \div 10 \mathrm{M\Omega}] \end{array}$ = 325kΩ
- 6. Calculate R_{BIAS}: The minimum supply voltage for this circuit is 1.8V. Providing 5µA of supply current assures proper operation. Therefore: $R_{BIAS} = (V_{BATTMIN} - V_{REF}) \div I_{BIAS} = (1.8V - 1.2V) \div 5\mu A$ = 120kΩ



Figure 7. Battery Monitor

PORTABLE GAS METER



Figure 8. Portable Gas Meter Application



LTC8821, LTC8822, LTC8824 Ultra-Low Power 500kHz, 1.8V, Low-Noise, RRIO CMOS Amplifiers

TAPE DIMENSIONS

Tape and Reel Information



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QUADRANT ASSIGNMENTS FOR PIN 1 ORIETATION IN TAPE



* All dimensions are nominal

Device	Package Type	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin 1 Quadrant
LTC8821XT5/R6	SOT23	5	3 000	178	9.0	3.3	3.2	1.5	4.0	8.0	Q3





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LTC8821, LTC8822, LTC8824 Ultra-Low Power 500kHz, 1.8V, Low-Noise, RRIO CMOS Amplifiers

Package Outlines

DIMENSIONS, SC70-5L (SOT353)



Symbol		nsions meters	Dimensions In Inches		
	Min	Max	Min	Max	
А	0.90	1.10	0.035	0.043	
A1	0.00	0.10	0.000	0.004	
A2	0.90	1.00	0.035	0.039	
b	0.15	0.35	0.006	0.014	
С	0.08	0.15	0.003	0.006	
D	2.00	2.20	0.079	0.087	
Е	1.15	1.35	0.045	0.053	
E1	2.15	2.45	0.085	0.096	
е	0.65	typ.	0.02	6 typ.	
e1	1.20	1.40	0.047	0.055	
L	0.52	0.525 ref.		l ref.	
L1	0.26	0.46	0.010	0.018	
θ	0°	8°	0°	8°	

RECOMMENDED SOLDERING FOOTPRINT, SC70-5L (SOT353)





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DIMENSIONS, SOT23-5L



RECOMMENDED SOLDERING FOOTPRINT, SOT23-5L



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DIMENSIONS, DFN1.5x1.5-8L



Symbol	Millimeters						
	Min.	Nom.	Max.				
Α	0.48	0.53	0.58				
A1		0.127 REF.					
b	0.15	0.20	0.25				
D	1.45	1.50	1.55				
D2	1.15	1.20	1.25				
E	1.45	1.50	1.55				
E2	0.65	0.70	0.75				
е		0.40 BSC.					
L	0.125	0.175	0.225				

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RECOMMENDED SOLDERING FOOTPRINT, DFN1.5x1.5-8L



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Package Outlines (continued)

DIMENSIONS, DFN2x2-8L



RECOMMENDED SOLDERING FOOTPRINT, DFN2x2-8L





DIMENSIONS, MSOP-8L



RECOMMENDED SOLDERING FOOTPRINT, MSOP-8L







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DIMENSIONS, SOIC-8L



Symbol		nsions meters	Dimensions In Inches		
	Min	Max	Min	Max	
Α	1.370	1.670	0.054	0.066	
A1	0.070	0.170	0.003	0.007	
A2	1.300	1.500	0.051	0.059	
b	0.306	0.506	0.012	0.020	
С	0.203	TYP.	0.008 TYP.		
D	4.700	5.100	0.185	0.201	
Е	3.820	4.020	0.150	0.158	
E1	5.800	6.200	0.228	0.244	
е	1.270	1.270 TYP.		TYP.	
L	0.450	0.750	0.018	0.030	
θ	0 °	8°	0°	8°	

RECOMMENDED SOLDERING FOOTPRINT, SOIC-8L





DIMENSIONS, TSSOP-14L



RECOMMENDED SOLDERING FOOTPRINT, TSSOP-14L





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DIMENSIONS, SOIC-14L



RECOMMENDED SOLDERING FOOTPRINT, SOIC-14L



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